

# LI WEI (NEWAY) 李巍

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Ph.D. Candidate ◊ Department of Electrical and Computer Engineering ◊ CMU ◊ [wadmes.github.io/cv/](https://wadmes.github.io/cv/)

## HIGHLIGHTS

**Vision:** Pioneering **Autonomous EDA** via multi-modal agents and differentiable optimization to enable self-evolving design cycles with orders-of-magnitude acceleration.

**Funding:** Awarded **\$500,000+** in fellowships: Croucher (\$200k), Apple (\$100k×2), and Qualcomm (\$100k).

**Impact:** **4 Best Papers/Mentions** (ASP-DAC, ICLAD, etc.); NVIDIA Patent (Global Routing) ; Algorithms integrated into Apple production; Ongoing collaborations with Google, Intel, Broadcom, and more.

**Leadership:** Evaluated faculty candidates on the CMU ECE Faculty Search Committee; mentored 8+ students with placements at Stanford PhD, CMU PhD, and NVIDIA.

## EDUCATION

<b>Carnegie Mellon University, PA, USA</b>	2021 – Present
<b>Doctor of Philosophy</b> , Department of Electrical and Computer Engineering Advisor: Professor Shawn Blanton & Professor José Moura	
<b>The Chinese University of Hong Kong, Hong Kong</b>	
<b>Master of Philosophy</b> , Department of Computer Science and Engineering Thesis: <i>Irregular Deep Data Embedding and Learning</i> ( <b>Faculty Outstanding Thesis Award</b> ) Supervisor: Professor Bei Yu	2019 – 2021
<b>Bachelor of Science, ELITE Stream</b> , Department of Computer Science and Engineering	2014 – 2018

## SELECTED AWARDS AND HONORS

### Fellowships & Scholarships

<b>Croucher Fellowship</b>	Croucher Foundation	2026
<i>Approx. \$200,000; 2-year stipend and research grant support. The most prestigious award for PhDs from HK.</i>		
<b>Qualcomm Innovation Fellowship</b>	Qualcomm Inc.	2024
<i>\$100,000 research grant; awarded for high-impact innovation globally in EDA.</i>		
<b>Apple PhD fellowship in Integrated Systems</b>	Apple Inc.	2024
<i>Approx. \$100,000; for elite IC PhD at designated premier universities; includes full funding and Apple mentorship.</i>		
<b>Apple PhD fellowship in Integrated Systems</b>	Apple Inc.	2022
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Jack and Mildred Bowers Scholarship	CMU	2025
Dean's Fellowship	CMU	2021
Talent Development Scholarship	HKSAR Government	2021
Full Postgraduate Studentship	CUHK	2019-2021
ELITE Stream Student Scholarship	Faculty of Engineering, CUHK	2018
Undergraduate Admission Scholarship	Soong Ching Ling Foundation	2015-2018

### Awards & Honors

<b>Best Paper Award, Honorable Mention</b>	ICLAD, top 3 out of 94 submissions	2025
<i>Invited for internal sharing at Apple (100+ attendees).</i>		
<b>Best Paper Award</b>	ASP-DAC, top 2 out of 368 submissions	2021
<b>Best Student Paper Award</b>	ICTAI, top 1 out of 458 submissions	2019
<b>Distinguished Paper Award</b>	ISSTA, top 3 out of 142 submissions	2019
<b>Faculty Outstanding Thesis Award</b>	Engineering Faculty, CUHK	2021
<i>Sole recipient of the best thesis award per year in the Faculty of Engineering..</i>		
1st Place Award in EDA elite challenge	Chinese Institute of Electronics	2020
Richard Newton Young Student Fellow	DAC	2020
2nd Place Award in CAD Contest	ICCAD	2018

## PATENTS

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- [P2] **Wei Li**, Rongjian Liang, Haoxing Ren. “Differentiable Global Router”. U.S. Patent Application 18/965,415, Filed Dec 2, 2024. Assigned to NVIDIA Corp. - Patent Pending.
- [P1] **Wei Li**, Ronald Blanton, Jose M. F. Moura. “System and Method for Global Floorplanning via Semidefinite Programming”. U.S. Patent Application 18/910,938, Filed: Oct 9, 2024 —Patent Pending.

## PUBLICATIONS

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### Journal Papers

- [J2] **Wei Li**, Yuzhe Ma, Yibo Lin, Bei Yu, “Adaptive Layout Decomposition with Graph Embedding Neural Networks”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (**TCAD**).
- [J1] **Wei Li**, Yuzhe Ma, Qi Sun, Zhang Lu, Yibo Lin, Iris Hui-Ru Jiang, Bei Yu, David Z. Pan, “OpenMPL: An Open Source Layout Decomposer”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (**TCAD**).

### Conference Papers

- [18] **Wei Li**, Yang Zou, Yixin Liang, Shawn Blanton and José Moura, “DEFT: Differentiable Framework for Circuit Testing”, ACM/IEEE Design Automation Conference (DAC), 2026, Under Review.
- [C17] **Wei Li**, Yang Zou, Christopher Ellis, Ruben Purdy, Shawn Blanton and José Moura, “BRIDGE: Bridging Graph and Large Language Models in EDA”, IEEE International Conference on LLM-Aided Design (**ICLAD**), 2025. (**Best Paper Award, Honorable Mention**)
- [C16] Chris Nigh, Ruben Purdy, **Wei Li**, Subhasish Mitra, R.D. Blanton, “ IC-PEPR: PEPR Testing Goes Intra-Cell”, IEEE International Test Conference (**ITC**), 2025.
- [C15] Ruben Purdy, Chris Nigh, **Wei Li**, R.D. Blanton, “CHEF: CHaracterizing Elusive Logic Circuit Failure” , IEEE VLSI Test Symposium (**VTS**) 2025.
- [C14] Chris Nigh, Ruben Purdy, **Wei Li**, Subhasish Mitra, R.D. Blanton, “Faulty Function Extraction for Defective Circuits” , IEEE European Test Symposium (**ETS**) 2024.
- [C13] **Wei Li**, Rongjian Liang, Anthony Agnesina, Haoyu Yang, Chia-Tung Ho, Anand Rajaram, Haoxing Ren, “DGR: Differentiable Global Routing”, ACM/IEEE Design Automation Conference (**DAC**), San Francisco, 2024.
- [C12] **Wei Li**, Ruben Purdy, Jose Moura, Shawn Blanton, “Characterize the ability of GNNs in attacking logic locking”, ACM/IEEE Workshop on Machine Learning for CAD (**MLCAD**), Snowbird, Utah, Sep. 11–13, 2023.
- [C11] **Wei Li**, Fangzhou Wang, Jose Moura, Shawn Blanton, “Global floorplanning via semidefinite programming”, ACM/IEEE Design Automation Conference (**DAC**), San Francisco, July 9-13, 2023.
- [C10] **Wei Li**, Chris Nigh, Danielle Duvalsaint, Subhasish Mitra, R.D. Blanton, “PEPR: Pseudo-Exhaustive Physical Region Testing”, IEEE International Test Conference (**ITC**), Sep. 25 - Sep. 30, 2022.
- [C9] **Wei Li**, Guojin Chen, Haoyu Yang, Ran Chen, Bei Yu, “Learning Point Clouds in EDA”, ACM International Symposium on Physical Design (**ISPD**), Mar. 21–Mar. 24, 2021.
- [C8] **Wei Li**, Yuxiao Qu, Gengjie Chen, Yuzhe Ma, Bei Yu, “TreeNet: Deep Point Cloud Embedding for Routing Tree Construction”, IEEE/ACM Asian and South Pacific Design Automation Conference (**ASP-DAC**), Tokyo, Jan. 18–21, 2021. (**Best Paper Award**)
- [C7] **Wei Li**, Jialu Xia, Yuzhe Ma, Jialu Li, Yibo Lin, Bei Yu, “Adaptive Layout Decomposition with Graph Embedding Neural Networks”, ACM/IEEE Design Automation Conference (**DAC**), San Francisco, July 19–23, 2020.
- [C6] Husheng Zhou, **Wei Li**, Yuankun Zhu, Yuqun Zhang, Bei Yu, Lingming Zhang, Cong Liu, “DeepBillboard: Systematic Physical-World Testing of Autonomous Driving Systems”, ACM/IEEE International Conference on Software Engineering (**ICSE**), Seoul, May 23–29, 2020.
- [C5] Yuzhe Ma, Zhuolun He, **Wei Li**, Tinghuan Chen, Lu Zhang, Bei Yu, “Understanding Graphs in EDA: From Shallow to Deep Learning”, ACM International Symposium on Physical Design (**ISPD**), Taipei, Mar. 25–Apr. 01, 2020.

- [C4] Yuzhe Ma, Ran Chen, **Wei Li**, Fanhua Shang, Wenjian Yu, Minsik Cho, Bei Yu, “A Unified Approximation Framework for Deep Neural Networks”, The IEEE International Conference on Tools with Artificial Intelligence (**ICTAI**) 2019. **(Best Student Paper Award)**
- [C3] **Wei Li**, Yuzhe Ma, Qi Sun, Yibo Lin, Iris Hui-Ru Jiang, Bei Yu, David Z. Pan, “OpenMPL: An Open Source Layout Decomposer”, IEEE International Conference on ASIC (**ASICON**), Chongqing, China, Oct. 29–Nov. 1, 2019.
- [C2] Xia Li, **Wei Li**, Yuqun Zhang, Yuqun Zhang, Lingming Zhang, “DeepFL: Integrating Multiple Fault Diagnosis Dimensions for Deep Fault Localization”, The ACM SIGSOFT International Symposium on Software Testing and Analysis (**ISSTA**), 2019. **(Distinguished Paper Award)**
- [C1] Bentian Jiang, Xiaopeng Zhang, Ran Chen, Gengjie Chen, Peishan Tu, **Wei Li**, Evangeline F. Y. Young, Bei Yu, “FIT: Fill Insertion Considering Timing”, ACM/IEEE Design Automation Conference (**DAC**), Las Vegas, NV, June 2-6, 2019.

## RESEARCH EXPERIENCE - IN UNIVERSITY

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**PhD candidate, Carnegie Mellon University, United States**

Aug. 2021 – Now

### **Multi-modal agentic LLMs for EDA**

- Introduces a new paradigm where EDA agents move beyond rigid, predefined APIs and interact with a unified, multi-modal representation of the design environment.
- Outlines two challenging case studies—automated RTL debugging and logic diagnosis—to demonstrate the framework’s effectiveness.
- Investigates the new problem-solving strategies that emerge from this increased agent autonomy.

### **DEFT: Differentiable Automatic Test Pattern Generation**

- Reformulated ATPG as a differentiable optimization with a new reparameterization
- Custom CUDA kernel achieves 4×–26× speedup on industrial circuits
- Improved HTD detection by 21%–49% under the same pattern budget
- Support practical ATPG features such as partial assignment, generating patterns with 19.3% fewer 0/1 bits while detecting 35% more faults

### **Graph Modality in LLMs for VLSI [ICLAD’25, Best Paper Honorable Mention]**

- Pioneered the integration of graph modality into LLMs specifically for VLSI design.
- Engineered a fully automated, high-throughput data collection pipeline, curating a massive-scale dataset with over 10 billion training tokens.
- Garnered exceptional interest from industry, invited to deliver an internal technical talk at **Apple** to an audience of 100+ engineers.

### **Global Floorplanning using Semidefinite Programming [DAC’23]**

- A SDP-based method for finding the best locations of modules in a chip; reduced wirelength by 3.02%–20.01%
- The industrial case study shows 500% quality improvement compared to the industrial tool.

### **Pseudo-Exhaustive Physically-Aware Region Testing [ITC’22]**

- Comprehensively analyze both the physical layout and the logic netlist to identify single- or multi-output sub-circuits.
- Implemented a novel tensor-based representation of layout polygon coordinates that enables a neighborhood search strategy that reduces computational complexity from  $O(n^2)$  to  $O(dn)$ .
- Implemented a GPU-based algorithm the physical sub-circuit extraction containing billions of sub-circuits.

### **GNN study in logic locking [MLCAD’23]**

- Modeled their ability to identify circuit changes that stem from a logic lock as the ability to decide the isomorphism between logic netlists.
- Showed that GNNs are always upper bounded by heterogeneous Weisfeiler Lehman test in deciding the netlist isomorphism, and gave the conditions when GNNs reach the bound.

**MPhil Student, The Chinese University of Hong Kong, Hong Kong**

Aug. 2019 – May. 2021

### **Routing Tree Construction [ASP-DAC’21, Best Paper Award]**

- Formalized special properties of the point cloud for the routing tree construction with theoretical proof.
- Proposed an adaptive flow, which used the cloud embedding obtained by a specifically-designed model based on special properties, to select the best approach and predict the best parameter.
- Outperformed previous methods by a large margin yet being extensible and flexible.

### **Adaptive Layout Decomposition [DAC’20, TCAD’21]**

- Proposed an adaptive workflow for efficient decomposer selection and graph matching using graph embeddings.
- Designed a graph library construction algorithm based on graph embeddings for small graphs excluding isomorphic ones.
- Reduced the runtime by 87.7% while still preserving the optimality compared with the ILP-based decomposer.

**Research Assistant, The Chinese University of Hong Kong, Hong Kong**

Feb. 2019 – July. 2019

### **Open-source Layout Decomposition Framework [TCAD’21]**

- Developed **OpenMPL**, a comprehensive open-source framework featuring high-performance implementations of state-of-the-art layout decomposition algorithms.
- Achieved **80+ GitHub stars**; the tool has been widely adopted as a baseline for benchmarking layout decomposition research.
- Identified critical algorithmic shortcomings in legacy heuristics and proposed optimized solutions that significantly improved decomposition success rates and scalability.

### **Acceleration and Compression of DNNs [ICTAI’19, Best Student Paper Award]**

- Proposed a unified framework to compress CNNs by combining both lowrankness and sparsity.

- Compressed the model with up to  $4.9\times$  reduction of parameters at a cost of little loss.

**Research Assistant, Southern University of Science and Technology, China** June. 2018 – Jan. 2019  
**Testing of Auto-driving Systems [ICSE'20]**

- Introduced a joint optimization method to systematically generate adversarial perturbations to mislead steering of an autonomous driving system physically.
- Demonstrated the possibility of continuous physical-world tests for auto-driving scenarios as the first study.

**Fault Localization [ISSTA'19, Distinguished Paper Award]**

- Proposed a hierarchical DL approach to learn the most effective features for precise fault localization.
- Significantly outperformed state-of-the-art with over 20% improvement.

## RESEARCH EXPERIENCE - IN INDUSTRY

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**Intern, SoC Physical Design Group, Apple, United States** May. 2024 – Aug. 2024  
**Floorplan Encoder**

- Propose a novel floorplan encoder for the floorplanning task, the encoder is capable of encoding the multi-modal and multi-objects floorplan state.
- Achieves 95% accuracy and shows 3X speedup to achieve the same quality compared to the industrial tool.

**Research Intern, Nvidia, United States** May. 2023 – Aug. 2023  
**Differentiable Global Routing [DAC'24]**

- A differentiable global router capable of concurrent optimization for millions of nets
- Reduced nets with overflow by more than 80%
- Resulted in a patent filing with NVIDIA Research; officially released as an [open-source framework](#) via NVIDIA Labs.

**Intern, SoC Physical Design Group, Apple, United States** June. 2022 – Sep. 2022  
**Exploration of GNNs for Physical Design**

- Implemented a basic GNN model for predicting holder buffer before routing.
- Evaluated multiple architectures, including path-based, sub-circuit based, and sub-graph based models.

**Perfect Rectilinear Floorplanning**

- A Simulated Annealing based algorithm for perfect rectilinear floorplanning.
- Reinforcement learning, and supervised-learning that guides SA are also explored.
- Integrated into physical design flows for large-scale SoC development.

## TEACHING EXPERIENCE

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**Carnegie Mellon University**  
**Head Teaching Assistant**

**18-765: Digital System Testing and Testable Design** Fall 2025

- Curated and coordinated a guest seminar series featuring **10+ industry leaders** from **Apple, Broadcom, Qualcomm, Siemens, and Synopsys** to bridge theoretical testing concepts with industrial practices.
- Architected and implemented an **automated grading system**, ensuring consistent feedback for students.
- Led weekly office hours and technical Q&A; coordinated the grading team to synchronize curriculum delivery.

**18-202: Mathematical Foundations of Electrical Engineering** Spring 2023

- Conducted weekly recitations to simplify complex mathematical concepts for graduate students.
- Managed course logistics, grading, and student consultations.

**Teaching Assistant**

**18-765: Digital System Testing and Testable Design** Fall 2022, Fall 2023, Fall 2024

- Developed and refined course assignments; provided in-depth technical support for projects.

**The Chinese University of Hong Kong**

**Head Teaching Assistant**

**CENG2030: Fundamentals of Embedded Systems** Spring 2021

**CENG3420: Computer Organization and Design** Spring 2020

- Designed and supervised weekly laboratory tutorials, focusing on hardware-software co-design and system-level performance.

MENTORING EXPERIENCE

Undergraduate Students Mentored

Aug 2024 - Present	Yang Zou [C17, 18]	CMU B.S.	Stanford Ph.D. soon
Aug 2019 - May 2020	Yuxiao Qu [C8]	CUHK B.S.	CMU Ph.D.
Aug 2019 - Dec 2019	Jialu Li [C7]	CUHK B.S.	HKUST M.Phil.
Aug 2019 - Dec 2019	Jialu Xia [C7]	CUHK B.S.	Spring Labs.

Graduate Students Mentored

Sep 2025 - Present	Rebecca Dettmar	CMU M.S.	In progress
Sep 2025 - Present	Zifeng Wang	CMU M.S.	In progress
Sep 2025 - Present	Andrew Kim	CMU M.S.	In progress
Sep 2025 - Jan 2026	Yixin Liang [18]	CMU M.S.	NVIDIA

PROFESSIONAL SERVICE

Journal & Conference Reviewer

- **Journals:** IEEE TCAD, IEEE TIFS, ACM TODAES, The ANZIAM Journal, Integration (the VLSI Journal).
- **Conferences** (Sub-reviewer/External): DAC, ITC, VTS, ETS.

Departmental Service

**Student Representative (Volunteer), CMU ECE Faculty Search Committee** 2025

- Participated in candidate interviews and social evaluations for Tenure-Track Assistant Professor applicants;
- Provided student-perspective feedback to the hiring committee.

**Volunteer, CMU ECE PhD Open House** 2025

- Mentored prospective PhD students and introduced research work;

**PhD Student Contact** 2026

- Provided insights to admitted PhD students about research and life at CMU; ßßß
- facilitated their transition into the program.

SELECTED INVITED TALKS

2026.02	Differentiable ATPG w. Mathematical Foundations	Apple
2026.01	Towards Autonomous EDA: Research and Vision	Recursive Intelligence (Founding Team)
2025.08	When LLMs Meet Graphs	Apple
2025.01	Review on ATPG and Fault Modeling	NVIDIA Research
2024.11	Differentiable Global Routing	Apple